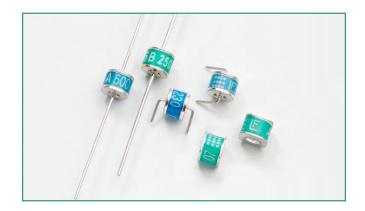


## SL1011A and SL1411A Series









#### **Agency Approvals**

AGENCY AGENCY FILE NUMBER

E128662

## 2 Electrode GDT Graphical Symbol



## **Additional Information**



Datasheet SL1011A



Datasheet SL1411A



Resources SL1011A



Resources SL1411A



Samples SL1011A



Samples SL1411A

#### **Description**

The SL1011A and SL1411A series provides high levels of protection against fast rising transients in the 100V/µs to 1kV/µs range usually caused by lightning disturbances.

The SL1011A and SL1411A series offers low capacitance (< 1.5pf) which provides low insertion loss at high frequencies.

SL1011A offers 5kA protection without destruction whereas the SL1411A offer 10kA surge protection without destruction (maximum single surge of 12kA @  $8/20\mu$ s).

#### **Features**

- RoHS compliant
- Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 5kA (SL1011A) or 10kA (SL1411A) surge capability tested with 8/20µs pulse as defined by IEC 61000-4-5

#### **Applications**

- Broadband equipment
- ADSL equipment
- XDSL equipment
- Satellite and CATV equipment
- General telecom equipment



## **Electrical Characteristics**

Device Specifications (at 25°C)				Life Ratings											
Part Number	DC B in art Number			Impulse Breakdown in Volts³ (@100V/µs)	Impulse Breakdown In Volts (@1kV/µs)	Insulation Resistance	Capaci- tance (@1MHz)	Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@100A 10/1000µs)	Nominal Impulse Discharge Current (8/20µs)	Nominal AC Discharge Current (10x1s @50-60Hz)	AC Dischage Current (9 Cycles @ 50Hz)	DC Holdover Voltage⁴	Discharg	mpulse e Current lication)
	MIN	TYP	MAX	MAX		MIN	MAX	TYP					TYP	@ 8/20μs	@ 10/350μs
SL1011A075 SL1411A075	60	75	90	500	700	10¹º Ω			300 shots	SL1011A: 10 shots (@5kA) SL1411A:	5 A 20 A			SL1411A: 12 kA	1 kA
SL1011A090 SL1411A090	72	90	108	500	600	(at 50V)	1.5 pF _^								
SL1011A145	116	145	174	500	650										
SL1011A150 SL1411A150	120	150	180	500	650							SL1411A:			
SL1011A230 SL1411A230	184	230	276	550	700										
SL1011A250 SL1411A250	200	250	300	600	800			~20 V							
SL1011A260	210	260	310	600	800	(at 100V)				10 shots (@10kA)					
SL1011A350 SL1411A350	280	350	420	800	900					(@TUKA)					
SL1011A470 SL1411A470	376	470	564	1000	1100										
SL1011A500	400	500	600	1100	1200										
SL1011A600 SL1411A600	480	600	720	1200	1400										

#### Notes:

- 1. At delivery AQL 0.65 level II, DIN ISO 2859
- In ionized mode
   Comparable to the silicon measurement Switching Voltage (Vs)
- 4. Tested according to ITU-T Rec. K.12 < 150 msecs.

#### **Product Characteristics**

Materials	<b>Leaded Device:</b> Nickel-plated with Tin- plated wires <b>Core and Surface Mount:</b> Dull Tin-plated	
Product Marking	Littelfuse 'LF' Mark, voltage and date code	

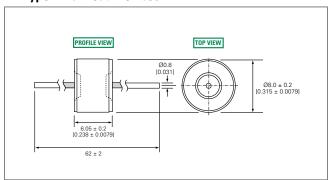
Glow to Arc Transition Current	< 0.5 Amps
Glow Voltage	~60 Volts
Storage and Operational Temperature	-40 to +90°C



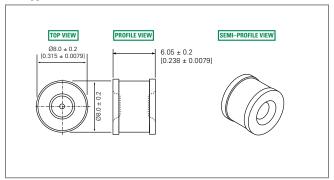
#### **Device Dimensions**

#### For SL1011A Series:

#### 'A' Type Axial Lead Devices

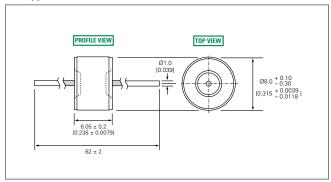


#### 'C' Type Core Devices

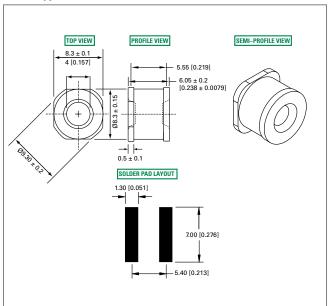


#### For SL1411A series:

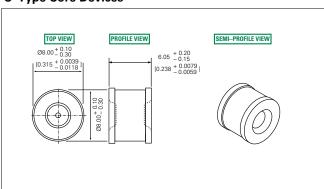
#### 'A' Type Axial Lead Devices



# 'SM' Type Surface Mount Devices



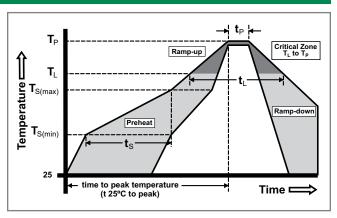
#### 'C' Type Core Devices



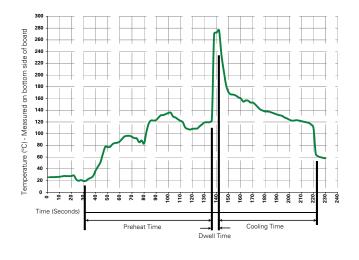


## **Soldering Parameters - Reflow Soldering (Surface Mount Devices)**

Reflow Co	ndition	Pb-free assembly		
	-Temperature Min (T <sub>s(min)</sub> )	150°C		
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C		
	-Time (Min to Max) (t <sub>s</sub> )	60 – 180 seconds		
Average R (T <sub>L</sub> ) to pea	amp-up Rate (LiquidusTemp k)	3°C/second max.		
$T_{S(max)}$ to $T_{L}$	- Ramp-up Rate	5°C/second max.		
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C		
nellow	-Temperature (t <sub>L</sub> )	60 – 150 seconds		
PeakTemp	erature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C		
Time with Temperatu	in 5°C of Actual Peak ıre (t <sub>p</sub> )	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max.		
Time 25°C	to Peak Temperature (T <sub>P</sub> )	8 minutes max.		
Do not exc	ceed	260°C		



## **Soldering Parameters - Wave Soldering (Thru-Hole Devices)**



# **Recommended Process Parameters:**

Wave Parameter	Lead-Free Recommendation		
Preheat:			
(Depends on Flux Activation Temperature)	(Typical Industry Recommendation)		
Temperature Minimum:	100° C		
Temperature Maximum:	150° C		
Preheat Time:	60-180 seconds		
Solder Pot Temperature:	280° C Maximum		
Solder DwellTime:	2-5 seconds		

## **Soldering Parameters - Hand Soldering**

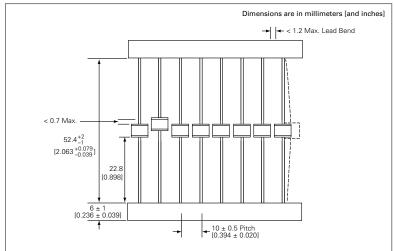
Solder Iron Temperature: 350° C +/- 5°C

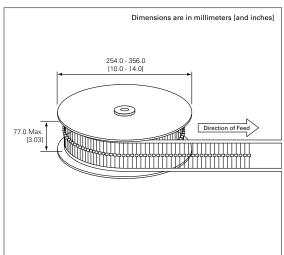
Heating Time: 5 seconds max.



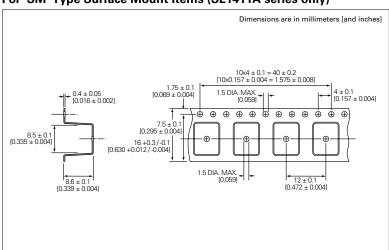
#### **Packaging Dimensions**

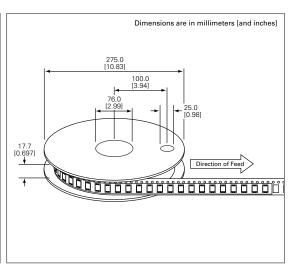
#### For Axial Lead Items





#### For 'SM' Type Surface Mount Items (SL1411A series only)





For 'C' Type Core Items: Packed in plastic bag (500 pcs)



## **Part Numbering System and Ordering Information**

# For SL1011A series:

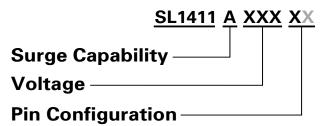
# SL1011A XXX X Voltage Pin Configuration

A = Axial Lead

C = Core

Remarks: Formed leads are available on request

# For SL1411A series:



A = Axial Lead

C = Core

SM = Surface Mount